

COMMON MODE FILTER CHOKE-JACM 4532V SERIES

Item	Performance	Test Condition				
Electrical Performance	e Test					
L	Refer to standard electrical characteristics list.	Agilent-4291A+ Agilent -16197A				
DCR		Agilent-4338B				
I.R.	51.01.050.151.55 1161.	Agilent-4339				
Operating Temperature	-55°C∼+150°C (Including self - temperature rise)					
Storage Temperature	-55°C~+125°C (on board)					
Temperature Rise Test	Rated Current < 1A ΔT 20°C Max Rated Current ≧ 1A ΔT 40°C Max	1.Applied the allowed DC current. 2.Temperature measured by digital surface thermometer.				
Reliability Test						
High Temperature Exposure(Storage) AEC-Q200		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) Temperature: 150±2°C Duration: 1000hrs Min. Measured at room temperature after placing for 24±2 hrs				
Temperature Cycling AEC-Q200		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) Condition for 1 cycle Step1: -55±2°C 30min Min. Step2: 150±2°C transition time 1min MAX. Step3: 150±2°C 30min Min. Step4: Low temp. transition time 1min MAX. Number of cycles: 1000 Measured at room temperature after placing for 24±2 hrs				
Moisture Resistance	Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) 1.Baked at50°C for 25hrs, measured at room temperature after placing for 4 hrs. 2.Raise temperature to 65±2°C 90-100%RH in 2.5hrs, ankeep 3 hours, cool down to 25°C in 2.5hrs. 3.Raise temperature to 65±2°C 90-100%RH in 2.5hrs, ankeep 3 hours, cool down to 25°C in 2.5hrs,keep at 25°C for 2hrs then keep at -10°C for 3hrs 4.Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.				
Biased Humidity (AEC-Q200)		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020DClassification Reflow Profiles) Humidity: 85±3% R.H, Temperature: 85°C±2°C Duration: 1000hrs Min with 100% rated current. Measured at room temperature after placing for 24±2 hrs				
High Temperature Operational Life (AEC-Q200)		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) Temperature: 150±2°C Duration: 1000hrs Min. with 100% rated current. Measured at room temperature after placing for 24±2 hrs				



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External Visual	Appearance : No damage	Inspect device construction, marking and workmanship. Electrical Test not required.						
Physical Dimension	According to the product specification size measurement	According to the product specification size measurement						
Resistance to Solvents	Appearance : No damage.	Add aqueous wash chemical - OKEM clean or equivalent.						
	Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the	Туре	Peak value (g's)	Normal duration (D)		Wave form	Velocity change (Vi)ft/sec	
Mechanical Shock		SMD	100	6		Half-sine	12.3	
INCCHAINCAI ONOCK	specification value.	Lead	100	6		Half-sine	12.3	
	RDC: within ±15% of initial value and shall not exceed the specification value	shocks in each direction along 3 perpendicular axes.						
Vibration		IPC/JEDEC J-STD-020D Classification Reflow Profiles Oscillation Frequency: 10Hz~2KHz~10Hz for 20 minute Equipment: Vibration checker Total Amplitude:1.52mm±10% Testing Time: 12 hours (20 minutes, 12 cycles each of 3 orientations)						
Resistance to Soldering Heat	Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value	Tem	condition: nperature(°C) 260±5 older temp)	а	ramp/i and em	nperature immersior nersion rat /s ±6 mm/	e neat cycles	
Thermal shock (AEC-Q200)	and shall not exceed the specification value		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) Condition for 1 cycle Step1: -55±2°C 15±1min Step2: 150±2°C within 20Sec. Step3: 150±2°C 15±1min Number of cycles: 300 Measured at room temperature after placing for 24±2 hrs					
ESD	Appearance: No damage.	10% Time (ns)						
Solderability	More than 95% of the terminal electrode should be covered with solder •	Steam Aging: 16 hours ± 15 min Preheat: 150°C,60sec. Solder: Sn96.5% Ag3% Cu0. 5% Temperature: 245±5°C° Flux for lead free: Rosin. 9.5%° Dip time: 4±1sec. Depth: completely cover the termination						



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Electrical Characterization	Refer Specification for Approval	Summary to show Min, Max, Mean and Standard deviation
Flammability	Electrical Test not required	V-0 or V-1 are acceptable.
		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) Place the 100mm X 40mm board into a fixture similar to the one shown in below Figure with the component facing down. The apparatus shall consist of mechanical means to apply a force which will bend the board (D) x = 2 mm minimum. The duration of the applied forces shall be 60 (+ 5) sec. The force is to be applied only once to the board.
Board Flex	Appearance : No damage	Support Solder Chip Printed circuit board before testing 45±2 KKI212-4
		Printed circuit board under test Printed circuit board under test Displacement
		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) With the component mounted on a PCB with the device to be tested, apply a 17.7 N (1.8 Kg) force to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.
Terminal Strength(SMD)	Appearance : No damage	DUT wide thickness substrate press tool shear force

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Soldering	Mildly activated rosin fluxes are preferred. JANTEK terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.			
Solder re-flow:	Recommended temperature profiles for re-flow soldering in Figure 1.			
Soldering Iron(Figure 2):	Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. Note: • Preheat circuit and products to 150°C • Never contact the ceramic with the iron tip • Use a 20 watt soldering iron with tip diameter of 1.0mm • 350°C tip temperature (max) • 1.0mm tip diameter (max) • Limit soldering time to 4~5 sec			



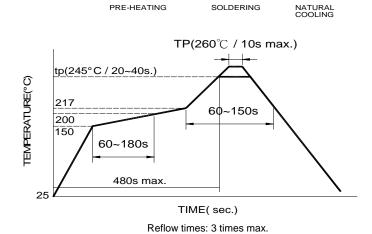
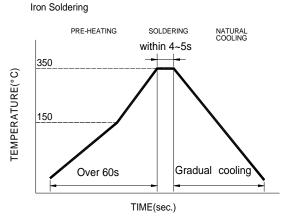


Fig.1



Iron Soldering times: 1 times max.

Fig.2